



# DATA SHEET SURFACE MOUNT MULTILAYER

**CERAMIC CAPACITORS** Automotive grade

with Soft Termination

X7R 10 V to 250 V I nF to 4.7 uF RoHS compliant & Halogento Free



## YAGEO Phícomp

Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

#### <u>SCOPE</u>

This specification describes Automotive grade X7R series chip capacitors with flexible leadfree terminations and used for automotive equipments.

#### APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

#### FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- Save PCB space
- The capacitors are 100% performed by automatic optical inspection prior to taping.

#### ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

#### **GLOBAL PART NUMBER**

AS <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

#### (I) SIZE - INCH BASED (METRIC)

0805 (2012) / 1206 (3216)/ 1210 (3225)

#### (2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

#### (3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- K = Blister taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch
- F = Blister taping reel; Reel 13 inch

#### (4) TC MATERIAL

X7R

#### (5) RATED VOLTAGE

- 8 = 25 V 9 = 50 V 0 = 100 V
- A = 200 V Y = 250 V

#### (6) PROCESS

B = Class 2 MLCC

#### (7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

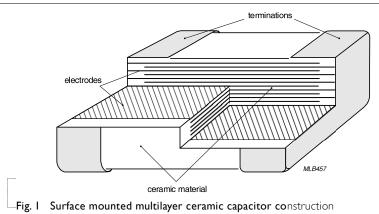
Example:  $|2| = |2 \times |0| = |20 \text{ pF}$ 

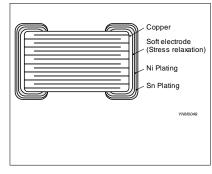
#### **CONSTRUCTION**

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end flexible terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. A cross section of the structure is shown in Fig.1 and Fig.2.





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Product specification

#### **DIMENSION**

 Table I
 For outlines see fig. 3

1		0				
TYPE	LI (mm)	W (mm)	T (mm)	L2/L3(mm) min	L2/L3(mm) max	L4(mm) min
0603	1.6 ± 0.2	0.8 ± 0.15	0.8 ± 0.15	0.20	0.65	0.50
0805	2.0 + 0.3	1.25 + 0.2	0.85 ± 0.15	- 0.25	0.75	0.70
	2.0 ± 0.5		1.25 ± 0.20	- 0.23		
			$0.85 \pm 0.15$			
1206	$3.2 \pm 0.4$	1.6 ± 0.2	1.25 ± 0.20	0.25	0.85	1.50
			$1.60 \pm 0.20$			
1210	3.2 ± 0.5	$2.5 \pm 0.3$	2.5 ± 0.3	0.25	1.00	1.20

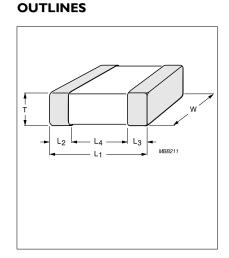


Table 2 Size	0805						
CAP.	0603				0805		
	16 V	25 V	50 V	100 V	25 V	50 V	100 V
I.0 nF					0.85±0.15	0.85±0.15	0.85±0.15
I.5 nF					0.85±0.15	0.85±0.15	0.85±0.15
2.2 nF					0.85±0.15	0.85±0.15	0.85±0.15
3.3 nF					0.85±0.15	0.85±0.15	0.85±0.15
4.7 nF					0.85±0.15	0.85±0.15	0.85±0.15
6.8 nF					0.85±0.15	0.85±0.15	0.85±0.15
I0 nF					0.85±0.15	0.85±0.15	0.85±0.15
I5 nF					0.85±0.15	0.85±0.15	0.85±0.15
22 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
33 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
47 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
68 nF	0.8±0.15	0.8±0.15	0.8±0.15		1.25±0.2	1.25±0.2	1.25±0.2
100 nF	0.8±0.15	0.8±0.15	0.8±0.15		1.25±0.2	1.25±0.2	1.25±0.2
l uF					1.25±0.2		

#### CAPACITANCE RANGE & THICKNESS FOR X7R

#### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm

#### CAPACITANCE RANGE & THICKNESS FOR X7R

Table 3 Size 120	)6				
CAP.	1206				
	16V	25V	50 V	100 V	250 V
22 nF	<u> </u>	-		-	1.25±0.2
33 nF					1.25±0.2
47 nF					1.25±0.2
68 nF					1.25±0.2
100 nF		0.85±0.15	0.85±0.15	1.25±0.2	1.6±0.2
150 nF		1.25±0.2	1.25±0.2	1.25±0.2	
220 nF	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	

Table 4	Size	1210	
CAP.			1210
			50 V
4.7 u	F	2.	5±0.3

#### NOTE

Values in shaded cells indicate thickness class in mm



Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

#### Table 5 Ø180 MM / 7 INCH Ø330 MM / 13 INCH TAPE WIDTH SIZE THICKNESS Blister Paper Blister Paper CLASSIFICATION QUANTITY PER REEL CODE 0603 0.8 ±0.15 mm 8 mm 4,000 ---15,000 ----0.85 ±0.15 mm 8 mm 4,000 15,000 -------0805 1.25 ±0.2 mm ----3,000 10,000 8 mm ----0.6 ±0.1 mm 8 mm 4,000 ----20,000 ----0.85 ±0.1 mm 4,000 15,000 8 mm -------1206 1.25 ±0.2 mm 8 mm ----3,000 ----10,000 1.6 ±0.2 mm 8 mm ----2,000 ----10,000 1210 2.5 ±0.3 mm 1,000 8 mm ------------

#### THICKNESS CLASSES AND PACKING QUANTITY

7

17

Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

#### ELECTRICAL CHARACTERISTICS

#### NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 6						
DESCRIPTION	1					VALUE
Capacitance ra	nge				1	nF to 4.7 uF
Capacitance to	lerance					
X7R					±5% <sup>(I)</sup> , ±	10%, ±20%
Dissipation fact	tor (D.F.)					
X7R		0603	0805	1206	1210	
	≤IOV		InF to 100uF	22nF to 220nF		≤ 5%
	16V	22nF to 100nF	InF to 100nF	22nF to 220nF		≤ 3.5%
			680nF to IuF			≤ 5%
	25V	22nF to 39nF	InF to 100nF	22nF to 220nF		≤ 2.5%
						≤ 3.5%
	50V	22nF to 39nF	InF to 100nF	22nF to 220nF		≤ 2.5%
		47nF to 100nF	220nF to 470nF			≤ 3.5%
					4.7 uF	$\leq 5\%$
	100V		InF to 100nF	22nF to 220nF		≤ 2.5%
		47nF to 100nF				≤ 5%
	250V			22nF to 100nF		≤ 2.5%
Insulation resis minute at U <sub>r</sub> (E				$IR \ge 10 \text{ G}\Omega \text{ or } I.R \times$	C ≥ 500Ω.F whicl	never is less
function of terr (temperature c	citance change as perature characteristic/coef					
X7R						±15%
Operating tem	perature range:					
X7R					–55 °C ·	to +125 °C

#### NOTE

I. Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales force before order



Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

#### SOLDERING RECOMMENDATION

Table 7

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

#### SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202F-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 270 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

#### TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20°C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$ , measuring at voltage $1 \text{ V}_{rms}$ at 20°C $f = 1 \text{ KHz}$ for $C > 1 \text{ nF}$ , measuring at voltage $1 \text{ V}_{rms}$ at 20°C Class 2: At 20°C, 24 hours after annealing $f = 1 \text{ KHz}$ , measuring at voltage $1 \text{ V}_{rms}$ at 20°C	Within specified tolerance	
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20°C, 24 hours after annealing $f = I MHz$ for $C \le InF$ , measuring at voltage $I V_{rms}$ at 20°C $f = I KHz$ for $C > InF$ , measuring at voltage $I V_{rms}$ at 20°C Class 2: At 20 °C, 24 hours after annealing $f = I KHz$ , measuring at voltage $I V_{rms}$ at 20°C	In accordance with specification	
Insulation Resistance	IEC 60384- 21/22	4.5.3	At $U_r$ (DC) for 1 minute	In accordance with specification	

Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature coefficient	4.6	Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. $\frac{\text{Step}  \text{Temperature}(^{\circ}\text{C})}{a  25\pm2}$ $\frac{\text{b}  \text{Lower temperature}\pm3^{\circ}\text{C}}{c  25\pm2}$ $\frac{\text{d}  \text{Upper Temperature}\pm2^{\circ}\text{C}}{e  25\pm2}$ (1) Class I Temperature Coefficient shall be calculated from the formula as below Temp, Coefficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^{6}$ [ppm/°C] C1: Capacitance at step c C2: Capacitance at 125°C $\Delta \text{T: } 100^{\circ}\text{C} (=125^{\circ}\text{C} - 25^{\circ}\text{C})$ (2) Class II Capacitance Change shall be calculated from the formula as below $\Delta \text{C} = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step c C2: Capacitance at step c C2: Capacitance at step c $\Delta \text{C} = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step c	<general purpose="" series=""> Class1: Δ C/C: ±30ppm Class2: X7R: Δ C/C: ±15% <high capacitance="" series=""> Class2: X7R/X5R: Δ C/C: ±15%</high></general>
High Temperature Exposure	AEC-Q200 3	Unpowered ; 1000hours @ T=150°C Measurement at 24±2 hours after test conclusion.	No visual damage Δ C/C : Class I : NP0: within ±0.5% or 0.5 pF whichever is greater Class2: X7R: ±10% D.F.: within initial specified value IR:

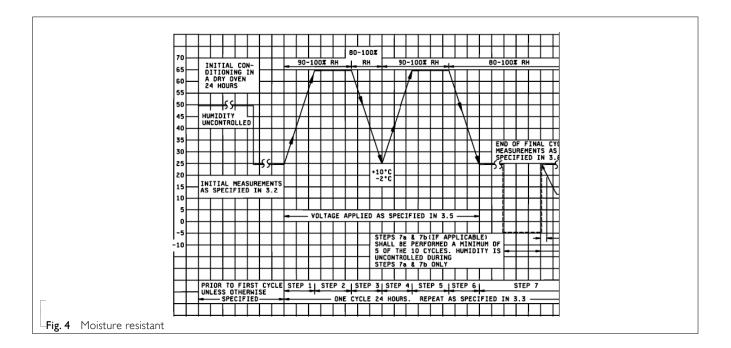
within initial specified value

**9** 17

Product specification

Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10°C for 1 hour, then keep for	No visual damage
, .			<ul> <li>24 ±1 hours at room temperature</li> <li>1000 cycles with following detail:</li> <li>30 minutes at lower category temperature</li> <li>30 minutes at upper category temperature</li> <li>Recovery time 24 ±2 hours</li> </ul>	$\Delta C/C$ Class I: NP0: Within $\pm 1\%$ or 0.5pF, whichever is greater. Class2: X7R: $\pm 10\%$ D.F. meet initial specified value
				IR meet initial specified value
Destructive Physical Analysis	AEC-Q200	5	10ea X 3 lots. Note: Only applies to SMD ceramics. Electrical test not required.	
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage
				$\Delta$ C/C NP0: Within ±3% or 3 pF, whichever is greater X7R: ±10%
				D.F. Within initial specified value IR NP0: $\geq$ 10,000 M $\Omega$ X7R: Meet initial specified value



Product specification 10

17

Product specification 11 Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Biased Humidity	AEC-Q200 7	I. Preconditioning, class 2 only: I50 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp	No visual damage after recovery
		<ul> <li>24 ±1 hour at room temp</li> <li>2. Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ &amp; 6.8 KΩ</li> <li>3. Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U<sub>r</sub> for 1,000 hours.</li> <li>4. Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours</li> <li>5. Final measure: IR</li> </ul>	Initial requirement: Class I: - Connected to 100 K $\Omega$ : C ≤ 10 nF: 1.R ≥ 10,000 M $\Omega$ or C > 10 nF: (1.R-100 K $\Omega$ ) × C ≥ 100s. - Connected to 6.8 K $\Omega$ : C ≤ 10 nF: 1.R ≥ 10,000 M $\Omega$ or C > 10 nF: (1.R-6.8 K $\Omega$ ) × C ≥ 100s. Class2: - Connected to 100 K $\Omega$ : C ≤ 25 nF: 1.R ≥ 4,000 M $\Omega$ o C > 25 nF: (1.R-100 K $\Omega$ ) × C ≥ 100s. - Connected to 6.8 K $\Omega$ : C ≤ 25 nF: 1.R ≥ 10,000 M $\Omega$ or C > 25 nF: (1.R-6.8 K $\Omega$ ) × C ≥ 100s. Final measurement: The insulation resistance shall be greater than 0.1 time initial value.

Phicomp Surface-Mount Ceramic Multilayer Capacitors Automotive grade NP0/X7R 6.3 V to 630 V

AEC-Q200	8	Ⅰ. Preconditioning, class 2 only: ↓50 +0/-10 °C /↓ hour, then keep for	No visual damage
		24 ±1 hour at room temp	$\Delta C/C$
		2. Initial measure:	NP0: Within ±2% or 1 pF,
		Spec: refer to initial spec C, D, IR	whichever is greater X7R: ±15%
		3. Endurance test:	
		Temperature: X7R: 125 °C	D.F.
			NP0: $\leq 2 \times$ specified value.
			$X7R: \le 16V: \le 7\%$
			≥ 25∨: ≤ 5%
			IR
			NP0: $\geq$ 4,000 M $\Omega$ or IR $\times$ C <sub>r</sub> $\geq$
			40s whichever is less
			X7R: ≥ 1,000 MΩ or IRx $C_r$ ≥ 50s whichever is less
			SUS WHICHEVER IS IESS
		5. Final measure: C, D, IK	
		Note: If the capacitance value is less than the minimum value	
		permitted, then after the other measurements have been	
		made the capacitor shall be preconditioned according to "IEC	
		60384 4.1" and then the requirement shall be met.	
AEC-Q200	9	Any applicable method using $\times$ 10 magnification	In accordance with specification
AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification
AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's	$\Delta$ C/C NP0: Within ±0.5% or 0.5 pF, whichever is greater X7R: ±10%
			D.F.
		vvaverorm. Half-sin	Within initial specified value
			IR
			Within initial specified value
450 0000	1.4		· · · · · · · · · · · · · · · · · · ·
AEC-Q200	14	-	$\Delta C/C$
		Note:	NP0: Within ±0.5% or 0.5 pF, whichever is greater
			X7R: ±10%
		mounted within 2" from any secure point. Test from – I 0-2000 Hz.	D.F: meet initial specified value IR meet initial specified value
	AEC-Q200	AEC-Q200 10 AEC-Q200 13	made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.         AEC-Q200       9       Any applicable method using × 10 magnification         AEC-Q200       10       Verify physical dimensions to the applicable device specification.         AEC-Q200       13       Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Vaveform: Half-sin         AEC-Q200       14       5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" × 5" PCB. 0.31" thick 7 secure points on one long side and 2 secure points at comers of opposite sides. Parts mounted within 2" from any secure point. Test from

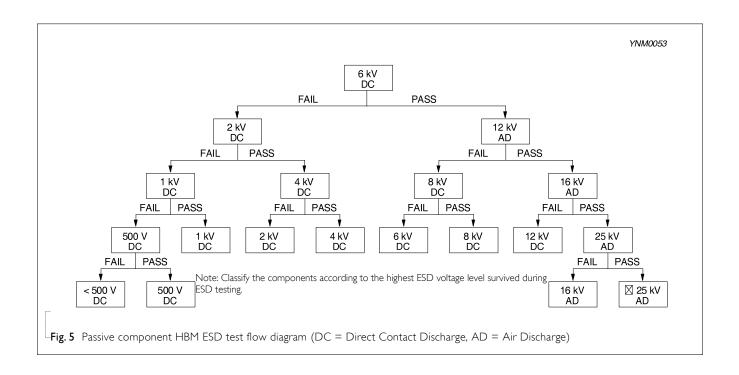
TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Resistance to Soldering Heat	AEC-Q200	15	Precondition: $150 \pm 0/-10$ °C for 1 hour, then keep for $24 \pm 1$ hours at room temperature Preheating: for size $\le 1206$ : $120$ °C to $150$ °C for 1 minute Preheating: for size $> 1206$ : $100$ °C to $120$ °C for 1 minute	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
			and 170 °C to 200 °C for 1 minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	$\Delta C/C$ Class I: NP0: Within ±1% or 0.5 pF, whichever is greater. Class2: X7R: ±10%
				D.F. within initial specified value
<b></b>				IR within initial specified value
Thermal Shock	AEC-Q200	16	<ol> <li>Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp</li> <li>Initial measure: Spec: refer to initial spec C, D, IR</li> <li>Rapid change of temperature test: NP0/X7R: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature.</li> <li>Recovery time: Class1: 6 to 24 hours Class2: 24 ±2 hours</li> <li>Final measure: C, D, IR</li> </ol>	No visual damage ΔC/C NP0: Within ±1% or 1 pF, whichever is greater X7R: ±15% D.F: meet initial specified value IR meet initial specified value
ESD	AEC-Q200	17	Per AEC-Q200-004	A component passes a voltage level if all components stressed at that voltage level pass.
Solderability	AEC-Q200	18	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination.
			Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: 1 Test conditions for lead-free containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: 1	

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS				
Electrical Characterization	AEC-Q200	19	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures.	x, Mean and Standard deviation at lax operating temperatures. C Class I: NP0: ±30 ppm/°C Class2: X7R: ±15%				
			Class I: NP0: -55 °C to +125 °C Normal temperature: 20 °C Class 2: X7R: -55 °C to +125 °C Normal temperature: 20 °C					
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm. Part should be mounted using the following soldering reflow profile. Conditions: Class2: Bending 5 mm at a rate of 1 mm/s, radius jig 230 mm	No visib ΔC/C Class2: X7R: ±1		age		
			Test Substrate:		Dimen	ision(m	ım)	
			$  \rightarrow   \qquad \phi 4.5 \qquad \text{YNSC147}$	Туре	а	b	c	
				0201	0.3	0.9	0.3	
				0402	0.4	1.5	0.5	
				0603	1.0	3.0	1.2	
				0805	1.2	4.0	1.65	
			100	1206	2.2	5.0	1.65	
			i <b>∢&gt;i</b> unit: mm	1210	2.2	5.0	2.0	
				1808	3.5	7.0	3.7	

Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal
			shock to the component being tested. * Apply 2N force for 0402 size.	junction. Before, during and after the test, the device shall comply
				with all electrical requirements stated in this specification.

<b>YAGEO</b>	Phicomp			Product specification	15
	Surface-Mount Ceramic Multilayer Capacitors	Automotive grade	NP0/X7R	6.3 V to 630 V	17

TEST TEST METHO		IOD	PROCEDURE	REQUIREMENTS		
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	$\leq$ 0805 Thickness > 0.5 mm: 20N Thickness $\leq$ 0.5 mm: 8N $\geq$ 1206 Thickness $\geq$ 1.25 mm: 54N Thickness $\leq$ 1.25 mm: 15N		
Voltage Proof	IEC 60384-1	4.6	Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur 100 V < Ur ≤ 200 V series applied (1.5 Ur + 100) 200 V < Ur ≤ 500 V series applied (1.3 Ur + 100) Ur > 500 V: 1.3 Ur Ur ≥ 1000 V: 1.2 Ur Charge/Discharge current is less than 50mA	No breakdown or flashover		



<b>YAGEO</b>	Phicomp			Product specification	16
	Surface-Mount Ceramic Multilayer Capacitors	Automotive grade	NP0/X7R	6.3 V to 630 V	17

#### <u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Oct. 05, 2017	-	- New

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17

17

Product specification